SUP90330E

www.vishay.com

Vishay Siliconix

N-Channel 200 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	200			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0375			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 7.5 V	0.0422			
Q _g typ. (nC)	21			
I _D (A)	35.1			
Configuration	Single			

FEATURES

- ThunderFET[®] power MOSFET
- Low R_{DS} Q_g figure-of-merit (FOM)
- Maximum 175 °C junction temperature
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Synchronous rectification
- Power supplies
- DC/AC inverter
- DC/DC converter
- Solar micro inverter
- Motor drive switch

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SUP90330E-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	200	N	
Gate-source voltage		V _{GS}	± 20	V	
Operation of the internet	T _C = 25 °C		35.8		
Continuous drain current	T _C = 125 °C	I _D	20.7		
Pulsed drain current (t = 100 µs)		I _{DM}	70	Α	
Continuous source-drain diode current		I _S	12.5		
Single pulse avalanche current ^a		I _{AS}	33		
Single pulse avalanche energy ^a	L = 0.1 mH	E _{AS}	54.45	mJ	
NAL THE REPORT OF A DESTRUCTION	T _C = 25 °C		125 ^b	w	
Maximum power dissipation	T _C = 125 °C	P _D	41.7 ^b		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	*0	
Soldering recommendations (peak temperature) ^c		Ť	260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	MAXIMUM	UNIT	
Maximum junction-to-ambient (PCB mount) ^c		R _{thJA}	40	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.2	0/10	

Notes

a. Duty cycle \leq 1 %

b. See SOA curve for voltage derating

c. When mounted on 1" square PCB (FR4 material)

S17-0649-Rev. A, 01-May-17

1



COMPLIANT

HALOGEN

FREE

www.vishay.com

SUP90330E

Vishay Siliconix

PARAMETER	SYMBOL TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	200	-	-	V
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	-	4	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	250	nA
		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	
Zero gate voltage drain current	I _{DSS}	V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 125 °C	-	-	150	μA
		V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 175 °C	-	-	5	mA
On-state drain current ^a	I _{D(on)}	$V_{DS} \geq 10 \ V, \ V_{GS} = 10 \ V$	20	-	-	Α
Drain acuras en stata registance à		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12.2 \text{ A}$	-	0.0312	0.0375	0
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 11.5 \text{ A}$	-	0.0337	0.0422	Ω
Forward transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	28	-	S
Dynamic ^b					•	•
Input capacitance	Ciss		-	1172	-	
Output capacitance	C _{oss}	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	150	-	pF
Reverse transfer capacitance	C _{rss}		-	11	-	
Total gate charge	Qg		-	21	32	nC
Gate-source charge	Q _{gs}	V_{DS} = 100 V, V_{GS} =10 V, I_{D} = 12.2 A	-	6	-	
Gate-drain charge	Q _{gd}		-	5.3	-	
Gate resistance	Rg	f = 1 MHz	0.76	3.8	7.6	Ω
Turn-on delay time	t _{d(on)}		-	12	24	
Rise time	t _r	$V_{DD} = 100 \text{ V}, \text{ R}_{L} = 14.2 \Omega, \text{ I}_{D} \cong 7 \text{ A},$	-	25	50	ns
Turn-off delay time	t _{d(off)}	V_{GEN} = 10 V, R_g = 1 Ω	-	30	50	
Fall time	t _f		-	22	44	
Drain-Source Body Diode Characteristi	cs		•	•		
Pulse diode forward current (t = 100 µs)	I _{SM}		-	-	70	Α
Body diode voltage	V _{SD}	I _F = 7 A, V _{GS} = 0 V	-	0.8	1.5	V
Body diode reverse recovery time	t _{rr}		-	111	170	ns
Body diode reverse recovery charge	Q _{rr}		-	0.51	1	μC
Reverse recovery fall time	ta	I _F = 7 A, di/dt = 100 A/μs	-	94	-	
Reverse recovery rise time	t _b		-	17	-	ns
Body diode peak reverse recovery charge	I _{RM(REC)}		-	8.5	17	Α

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},\,duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

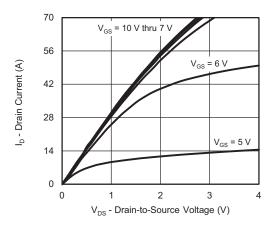
2



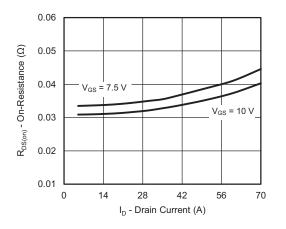
SUP90330E

Vishay Siliconix

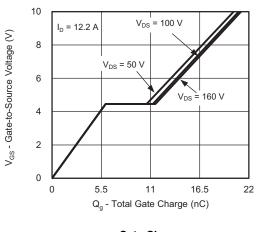
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



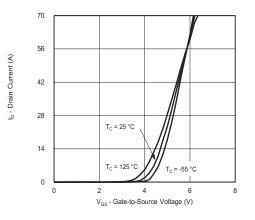
Output Characteristics



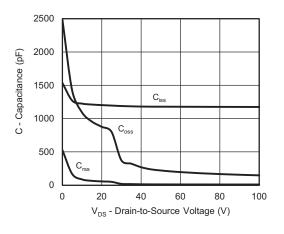
On-Resistance vs. Drain Current and Gate Voltage



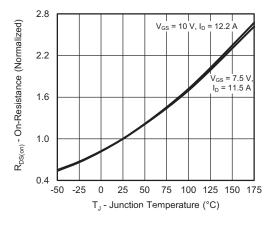
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

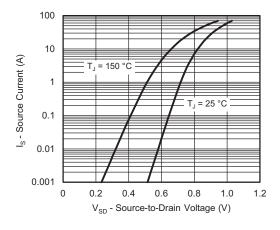
S17-0649-Rev. A, 01-May-17

3 stions, contact; pmostechsupp Document Number: 74528

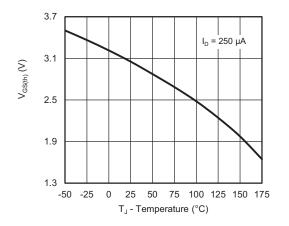
For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



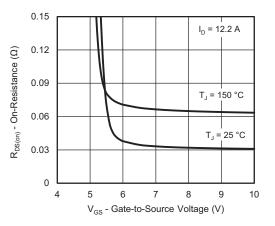
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



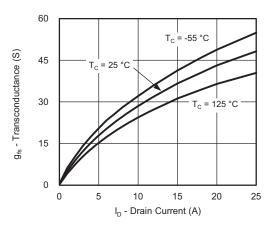
Source-Drain Diode Forward Voltage



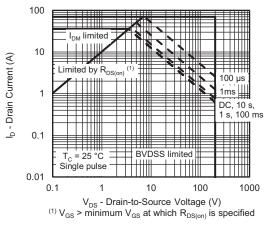
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Transconductance



Safe Operating Area, Junction-to-Ambient

S17-0649-Rev. A, 01-May-17

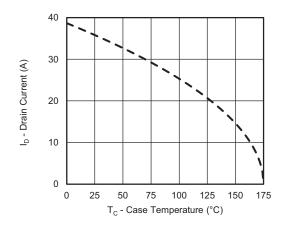
4 For technical questions, contact: <u>pmostechsupport@vishay.com</u>

Document Number: 74528

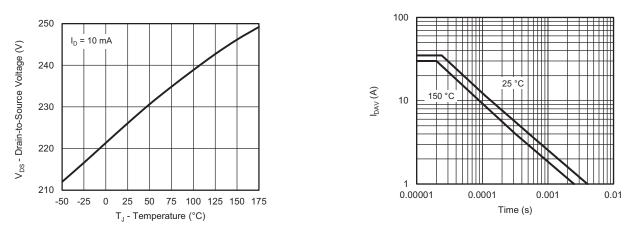
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a



Drain Source Breakdown vs. Junction Temperature

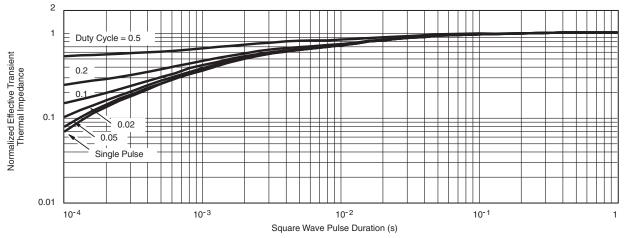
Avalanche vs. Time

Note

a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?74528.



TO-220AB



	MILLIMETERS		INC	CHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
	0413-Rev. P,		0.102	0.118	

Note

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by Vishay manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 2N7000 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C IPS70R2K0CEAKMA1 BUK954R8-60E DMN3404LQ-7 NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 US6M2GTR TK10A80W,S4X(S SSM6P69NU,LF